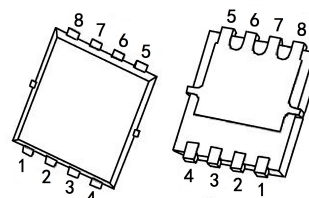


-40V P-Channel Mosfet

FEATURES

- $R_{DS(ON)} \leq 9m\Omega$ (7m Ω Typ.)
@ $V_{GS} = -10V$
- $R_{DS(ON)} \leq 13.5m\Omega$ (9m Ω Typ.)
@ $V_{GS} = -4.5V$
- AEC Q101 qualified
- Green Product (RoHS compliant)

PDFN5*6-8L

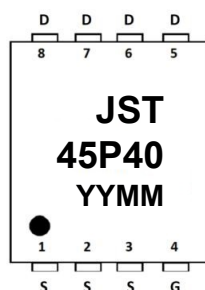


APPLICATIONS

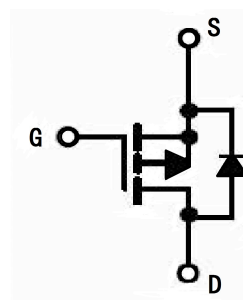
- Car Seat
- PWM Applications
- Load Switch
- Power Management

1: S 3: S 5: D 7: D
2: S 4: G 6: D 8: D

MARKING



P-CHANNEL MOSFET



MAXIMUM RATINGS ($T_C = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter		Max.	Units
V_{DSS}	Drain-Source Voltage		-40	V
V_{GSS}	Gate-Source Voltage		± 20	V
I_D	Continuous Drain Current @ $V_{GS} = 10V$ note1	$T_C = 25^\circ\text{C}$	-45	A
		$T_C = 100^\circ\text{C}$	-32	A
I_{DM}	Pulsed Drain Current note2		-180	A
P_D	Power Dissipation	$T_C = 25^\circ\text{C}$	33	W
$R_{\theta JC}$	Thermal Resistance, Junction to Case		4.5	$^\circ\text{C}/\text{W}$
T_J, T_{STG}	Operating and Storage Temperature Range		-55 to +175	$^\circ\text{C}$

MOSFET ELECTRICAL CHARACTERISTICS $T_C=25\text{ }^{\circ}\text{C}$ unless otherwise specified

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Units
Off Characteristic						
V _{(BR)DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D = -250μA	-40	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = -40V, V _{GS} =0V	-	-	-1	μA
I _{GSS}	Gate to Body Leakage Current	V _{DS} =0V, V _{GS} = ±20V	-	-	±100	nA
On Characteristics						
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D = -250μA	-1.0	-1.5	-2.5	V
R _{DS(on)}	Static Drain-Source on-Resistance <small>note3</small>	V _{GS} = -10V, I _D = -20A	-	7	9	mΩ
		V _{GS} = -4.5V, I _D = -15A	-	9	13.5	
Dynamic Characteristics <small>note4</small>						
C _{iSS}	Input Capacitance	V _{DS} = -20V, V _{GS} =0V, f=1.0MHz	-	4940	-	pF
C _{oSS}	Output Capacitance		-	427	-	pF
C _{rSS}	Reverse Transfer Capacitance		-	375	-	pF
Q _g	Total Gate Charge	V _{DS} = -20V, I _D = -20A, V _{GS} = -10V	-	54	-	nC
Q _{gs}	Gate-Source Charge		-	9.5	-	nC
Q _{gd}	Gate-Drain(“Miller”) Charge		-	11	-	nC
Switching Characteristics <small>note4</small>						
t _{d(on)}	Turn-on Delay Time	V _{DD} = -20V, I _D = -20A, V _{GS} = -10V, R _{GEN} =2.5Ω	-	13	-	ns
t _r	Turn-on Rise Time		-	27	-	ns
t _{d(off)}	Turn-off Delay Time		-	68	-	ns
t _f	Turn-off Fall Time		-	37	-	ns
Drain-Source Diode Characteristics and Maximum Ratings						
V _{SD}	Drain to Source Diode Forward Voltage	V _{GS} =0V, I _S = -20A	-	-	-1.2	V

Notes:1. $T_C=25\text{ }^{\circ}\text{C}$ Limited only by maximum temperature allowed. Calculated continuous current based on maximum allowable junction temperature.

2. $PW\leq 10\mu s$, Duty cycle $\leq 1\%$

3. Pulse Test: Pulse Width $\leq 300\mu s$, Duty Cycle $\leq 2\%$

4. Guaranteed by design, not subject to production testing

TYPICAL CHARACTERISTICS

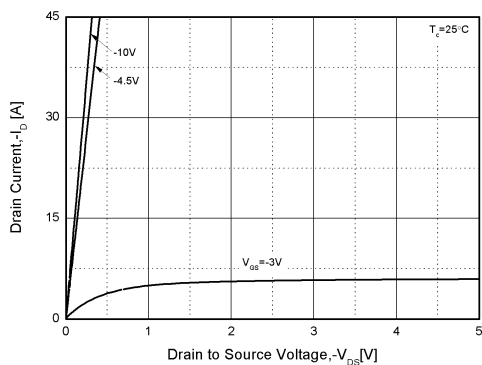


Figure1. Output Characteristics

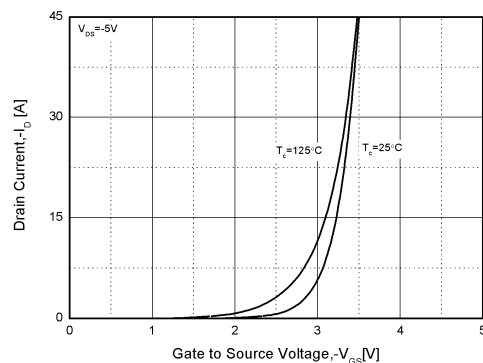


Figure2. Transfer Characteristics

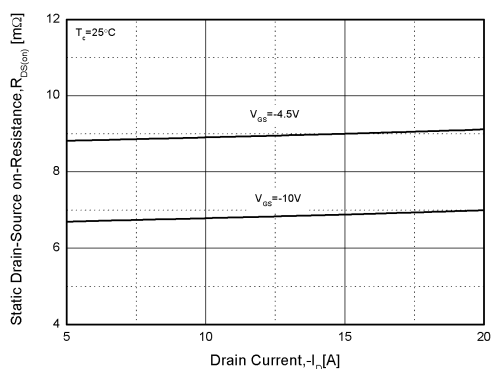


Figure3. Rdson-Drain Current

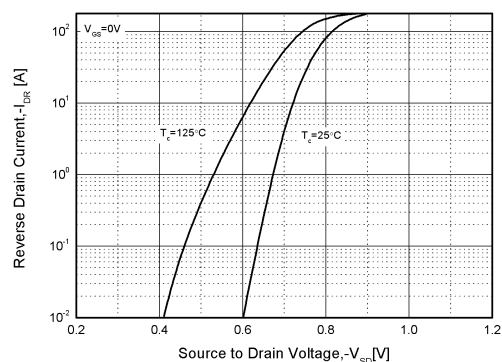


Figure4. Typical Source-Drain Diode Forward Voltage

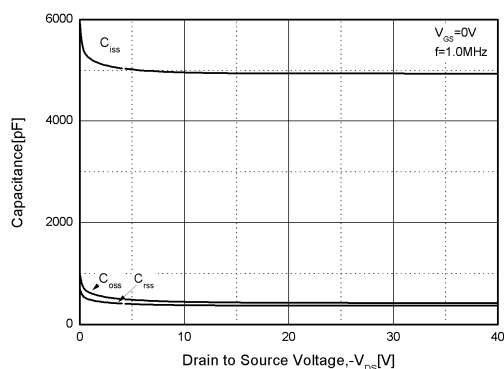


Figure5. Capacitance Characteristics

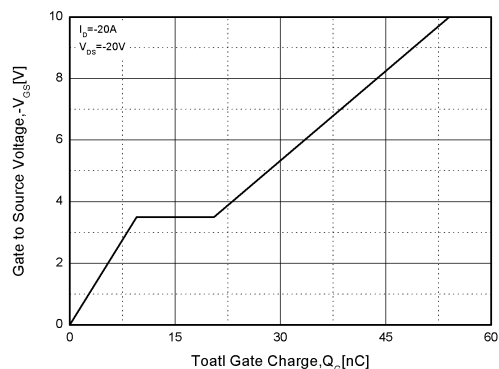


Figure6. Gate Charge

TYPICAL CHARACTERISTICS (cont.)

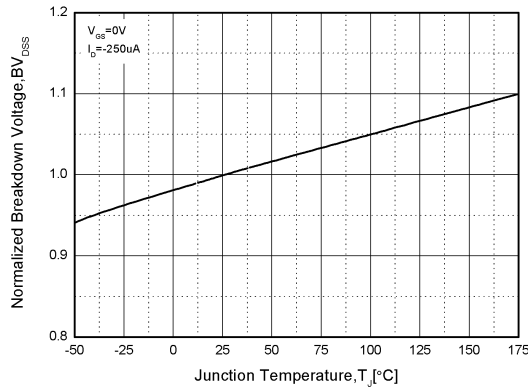


Figure7. Normalized Breakdown Voltage vs. Temperature

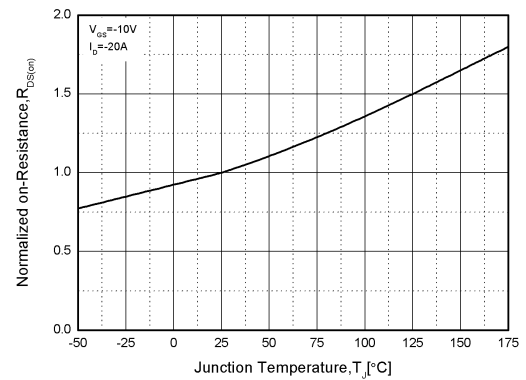


Figure8. Normalized on Resistance vs. Temperature

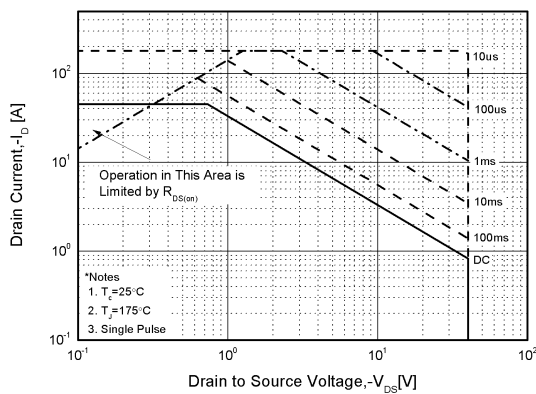


Figure9. Safe Operation Area

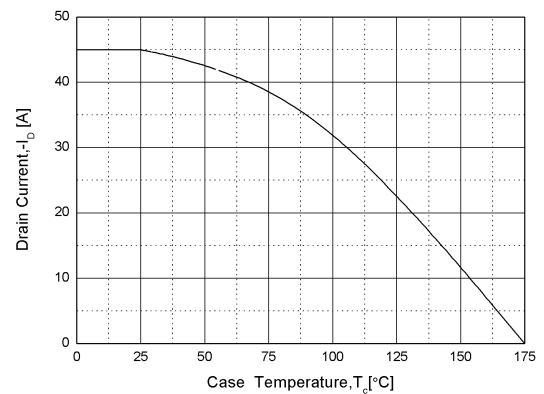


Figure10. Drain Current vs. Case Temperature

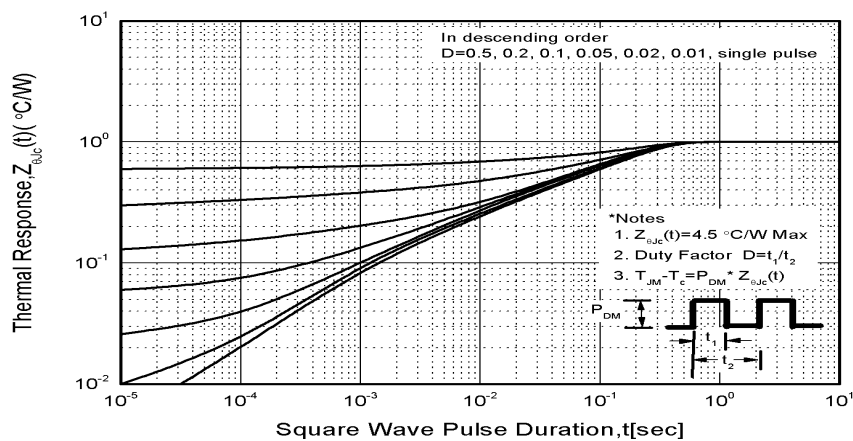
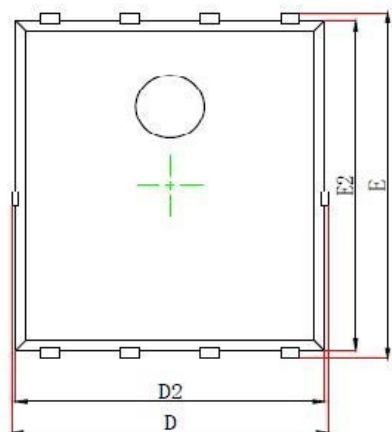
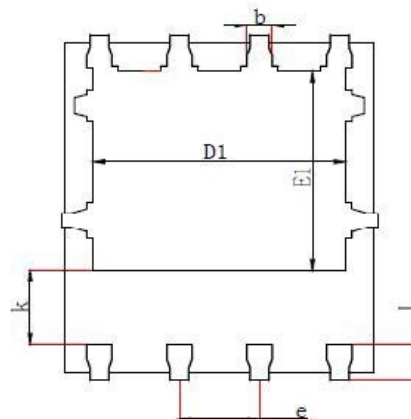


Figure11. Transient Thermal Response Curve

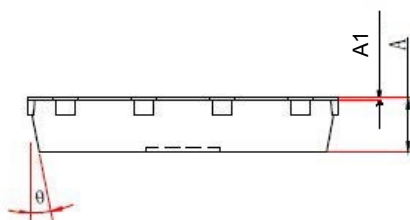
PDFN5*6-8L PACKAGE OUTLINE DRAWING



Top View
[顶视图]



Bottom View
[背视图]



Side View
[侧视图]

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.800	1.100	0.031	0.043
A1	0.000	0.05	0.000	0.002
D	-	5.4	-	0.212
E	-	6.250	-	0.246
D1	3.900	4.200	0.153	0.165
E1	3.350	3.650	0.132	0.144
D2	4.800	5.150	0.189	0.203
E2	5.500	5.950	0.216	0.234
k	1.100	1.500	0.043	0.059
b	0.250	0.510	0.010	0.020
e	1.170	1.370		
L	0.510	0.800	0.020	0.031
θ	6°	14°	6°	14°